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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE -

APPL NUM 10033546	FILING DATE 12/27/2001	CLASS 257	SUBCLASS 784	GAU 2814	EXAMINER KOREKH
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**APPLICANTS: Lin Fong-Long; Briner Michael;

**CONTINUING DATA VERIFIED:

** FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	ATTORNEY DOCKET NO 2102397-992070
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no			
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no			
Verified and Acknowledged Examiners's initials			
TITLE : Bond out chip and method for making same			

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
C		Total Claims 15	
Assistant Examiner		Print Claim for O.G.	
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner	
PREPARED FOR ISSUE		Application Examiner	
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